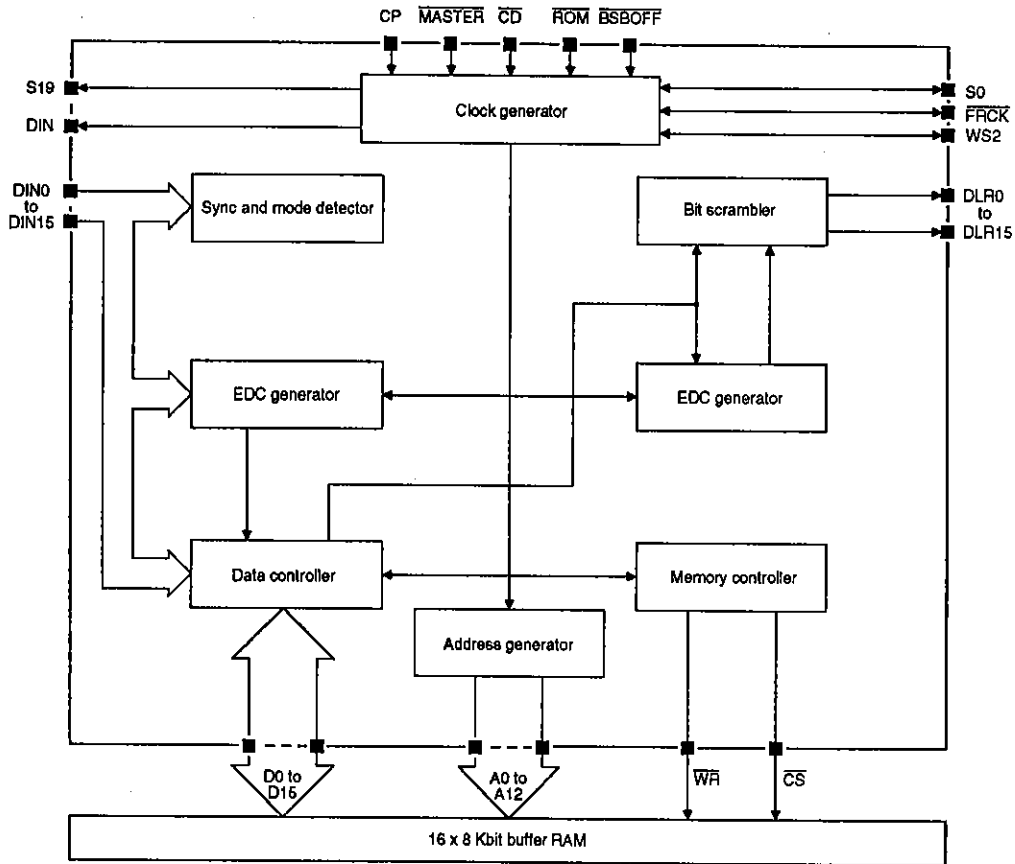


Block Diagram



Pin Functions

Number	Name	Function
69 to 72, 74 to 80, 1 to 5	DINO to DIN15	Data inputs
6 to 12, 14 to 19	A0 to A12	Buffer memory address bus
13, 32, 52	VSS	Ground
20	\overline{CS}	Buffer memory chip select output
21	S19	Input data start pulse output
22	\overline{WR}	Buffer memory write output
23 to 30, 33 to 40	D0 to D15	Buffer memory data bus
31, 73	VDD	Supply voltage
41 to 51, 53 to 57	DLR0 to DLR15	Encoded data outputs
58	S0	Data output sector input/output. See note.
59	FRCK	CD frame sync clock input/output. See note.
60	WS2	Double word sync clock input/output. See note.
61	MASTER	Slave/master mode select input. See note.
62	TEST	Test input. Internal pull-up resistor
63	BSBOFF	Bit scramble select input. Internal pull-up resistor

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Number	Name	Function
64	\overline{ROM}	CD-ROM or CD-I input data format select input. Internal pull-up resistor
65	CD	CD-ROM/CD-I or CD-DA input data format select input. Internal pull-up resistor
66	CP	Clock pulse input
67	DIN	Data input clock output
68	\overline{RESET}	Reset input

Note

\overline{MASTER} selects whether S0, \overline{FRCK} and WS2 are in input or output mode.

Specifications

Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Supply voltage range	V_{DD}	-0.3 to 7.0	V
Input voltage range	V_I	-0.3 to $V_{DD} + 0.3$	V
Output voltage range	V_O	-0.3 to $V_{DD} + 0.3$	V
Operating temperature range	T_{opr}	-30 to 70	°C
Storage temperature range	T_{stg}	-55 to 125	°C
Soldering temperature	T_{sol}	260	°C
Soldering time	t_{sol}	10	s

Recommended Operating Conditions

$T_a = 25\text{ °C}$

Parameter	Symbol	Ratings	Unit
Supply voltage	V_{DD}	5	V
Supply voltage range	V_{DD}	4.5 to 5.5	V

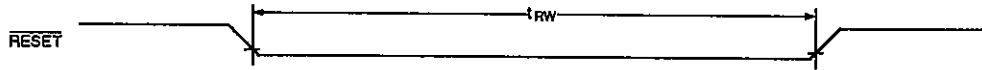
Electrical Characteristics

$V_{DD} = 4.5\text{ to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $T_a = -30\text{ to }70\text{ °C}$

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
LOW-level input voltage	V_{IL}		-	-	0.8	V
HIGH-level input voltage	V_{IH}		2.2	-	-	V
Input voltage	V_I		0	-	V_{DD}	V
LOW-level output voltage	V_{OL}	$I_{OL} = 3\text{ mA}$	-	-	0.4	V
HIGH-level output voltage	V_{OH}	$I_{OH} = 3\text{ mA}$	2.4	-	-	V

Timing Characteristics

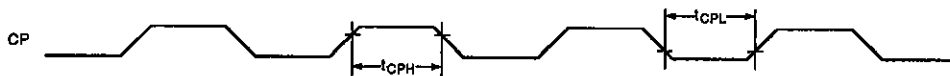
Reset timing



$V_{DD} = 4.5$ to 5.5 V, $T_a = -30$ to 70 °C, $C_L = 50$ pF, $V_H = 2.2$ V, $V_L = 0.8$ V

Parameter	Symbol	Ratings		Unit
		min	max	
RESET LOW-level pulsewidth	t_{RW}	$10/f_{CP}$	-	ns

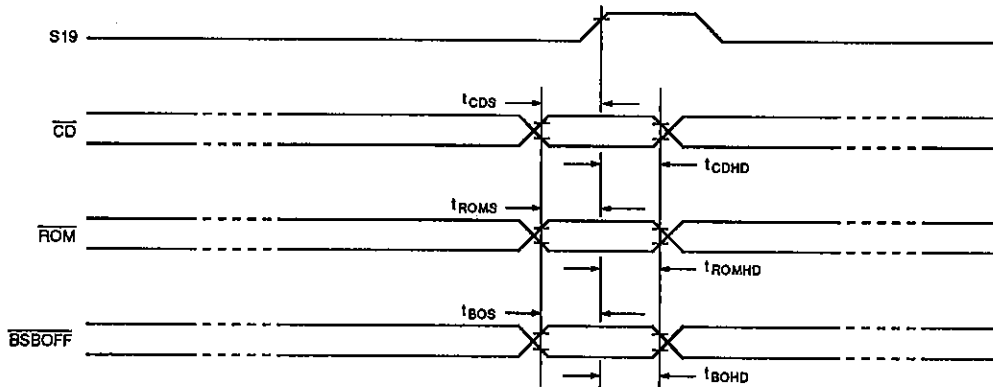
System clock timing



$V_{DD} = 4.5$ to 5.5 V, $T_a = -30$ to 70 °C, $C_L = 50$ pF, $V_H = 2.2$ V, $V_L = 0.8$ V

Parameter	Symbol	Ratings			Unit
		min	typ	max	
CP input frequency	f_{CP}	-	4.3216	-	MHz
CP LOW-level pulsewidth	t_{CPL}	80	-	-	ns
CP HIGH-level pulsewidth	t_{CPH}	80	-	-	ns

Encode mode set timing



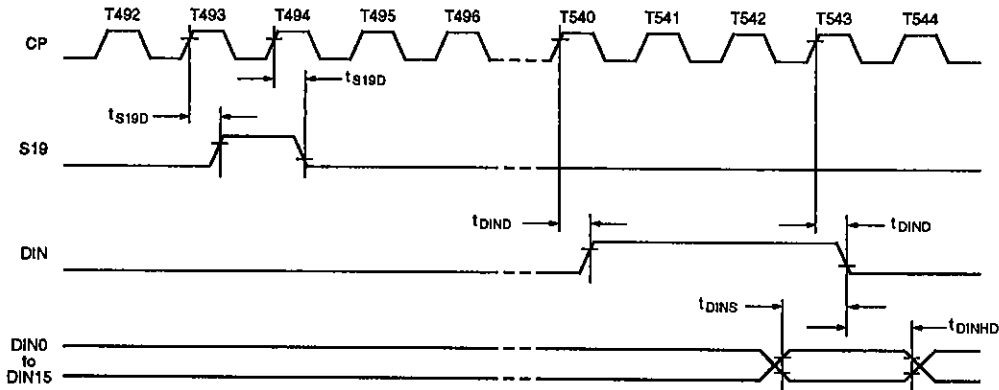
$V_{DD} = 4.5$ to 5.5 V, $T_a = -30$ to 70 °C, $C_L = 50$ pF, $V_H = 2.2$ V, $V_L = 0.8$ V

Parameter	Symbol	Ratings		Unit
		min	max	
CD setup time	t_{CDS}	-	30	ns
CD hold time	t_{CDHD}	-	5	ns
ROM setup time	t_{ROMS}	-	30	ns

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Parameter	Symbol	Ratings		Unit
		min	max	
ROM hold time	t_{ROMHD}	-	5	ns
\overline{BSBOFF} setup time	t_{BOS}	-	30	ns
\overline{BSBOFF} hold time	t_{BOHD}	-	5	ns

Data input timing



$V_{DD} = 4.5$ to 5.5 V, $T_a = -30$ to 70 °C, $C_L = 50$ pF, $V_H = 2.2$ V, $V_L = 0.8$ V

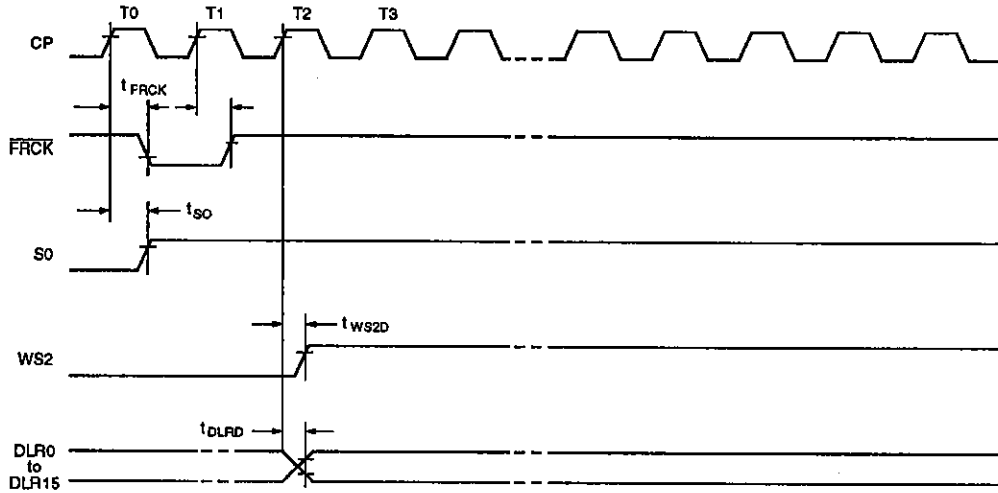
Parameter	Symbol	Ratings		Unit
		min	max	
S19 output delay time	t_{S19D}	-	70	ns
DIN output delay time	t_{DIND}	-	70	ns
DINO to DIN15 setup time	t_{DINS}	-	$2/t_{CP} + 70$	ns
DINO to DIN15 hold time	t_{DINH}	-	0	ns

Note

There are 588 CP cycles for each \overline{FRCK} cycle. \overline{FRCK} goes LOW in sync with the first cycle of CP (T0). DIN goes HIGH on the leading edge of CP cycles T44, T90, T136, T182, T228, T274, T320, T366, T412, T458, T504 and T550.

Data output timing

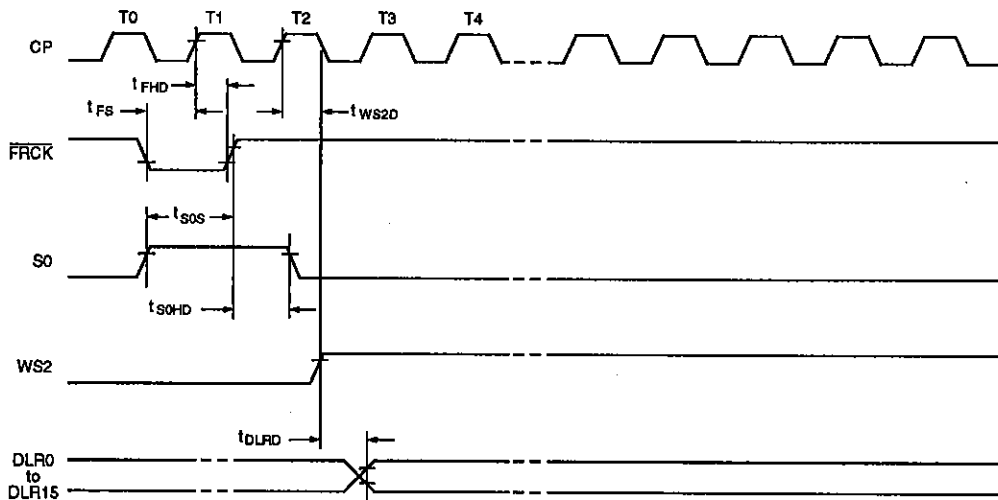
Master mode



$V_{DD} = 4.5$ to 5.5 V, $T_a = -30$ to 70 °C, $C_L = 50$ pF, $V_H = 2.2$ V, $V_L = 0.8$ V

Parameter	Symbol	Ratings		Unit
		min	max	
FRCK output delay time	t_{FD}	-	50	ns
S0 output delay time	t_{SO}	-	60	ns
WS2 output delay time	t_{WS2D}	-	50	ns
DLR0 to DLR15 output delay time	t_{DLRD}	-	100	ns

Slave mode



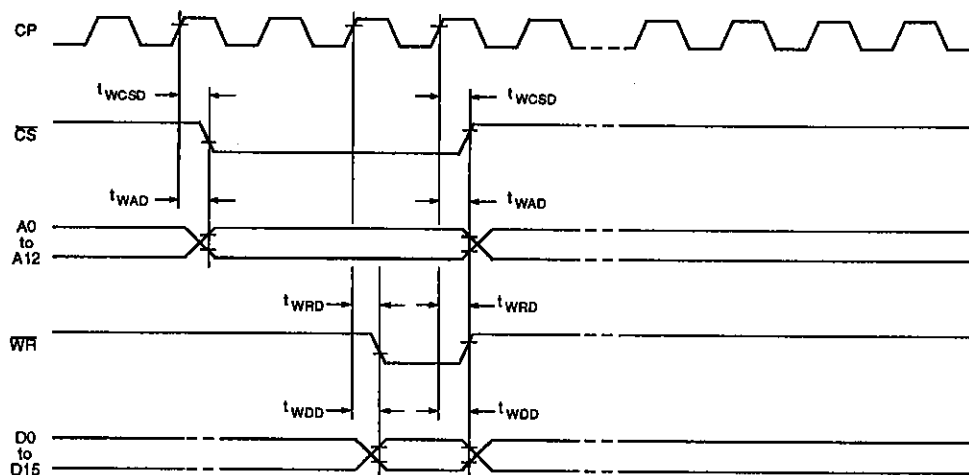
$V_{DD} = 4.5$ to 5.5 V, $T_a = -30$ to 70 °C, $C_L = 50$ pF, $V_H = 2.2$ V, $V_L = 0.8$ V

Parameter	Symbol	Ratings		Unit
		min	max	
FRCK input setup time	t_{FS}	5	-	ns
FRCK input hold time	t_{FHD}	10	-	ns

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Parameter	Symbol	Ratings		Unit
		min	max	
S0 input setup time	t_{S0S}	5	-	ns
S0 input hold time	t_{S0HD}	10	-	ns
WS2 input delay time	t_{WS2D}	10	100	ns
DLR0 to DLR15 output delay time	t_{DLRD}	-	80	ns

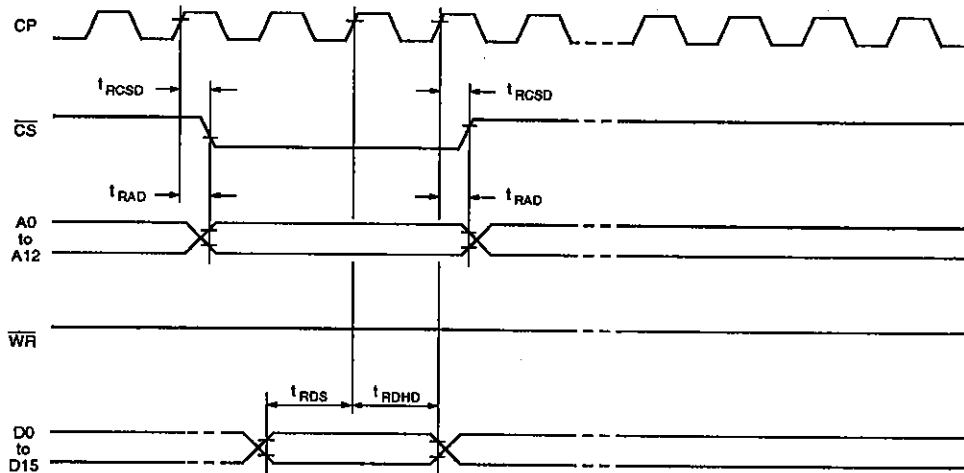
SRAM interface write cycle



$V_{DD} = 4.5$ to 5.5 V, $T_a = -30$ to 70 °C, $C_L = 50$ pF, $V_H = 2.2$ V, $V_L = 0.8$ V

Parameter	Symbol	Ratings		Unit
		min	max	
CS output delay time	t_{WCSD}	-	80	ns
A0 to A12 output delay time	t_{WAD}	-	100	ns
WR output delay time	t_{WRD}	-	60	ns
D0 to D15 output delay time	t_{WDD}	-	100	ns

SRAM interface read cycle



$V_{DD} = 4.5$ to 5.5 V, $T_a = -30$ to 70 °C, $C_L = 50$ pF, $V_H = 2.2$ V, $V_L = 0.8$ V

Parameter	Symbol	Ratings		Unit
		min	max	
CS output delay time	t_{RCSD}	-	70	ns
A0 to A12 address output delay time	t_{RAD}	-	100	ns
D0 to D15 input setup time	t_{RDS}	-	80	ns
D0 to D15 input hold time	t_{RDHD}	-	5	ns

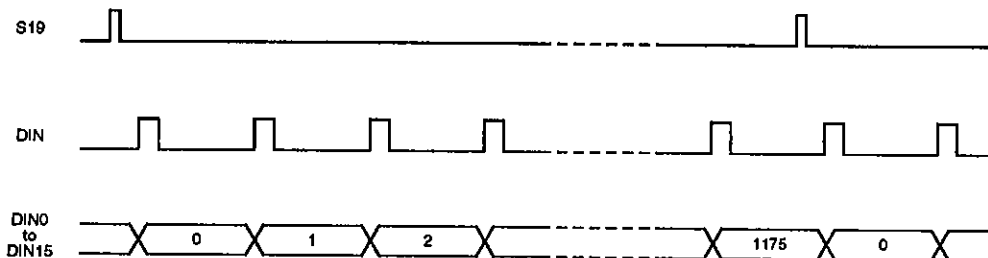
Functional Description

Input data is processed as CD-DA format data when \overline{CD} is LOW and as CD-ROM or CD-I format data when \overline{CD} is HIGH, depending on the state of \overline{ROM} . The data is processed as CD-ROM format data when \overline{ROM} is LOW, and as CD-I format data when \overline{ROM} is HIGH. Note that if a CD-ROM sync pattern is not detected in the input data, the data is processed as CD-DA format data, regardless of whether \overline{CD} is LOW or HIGH.

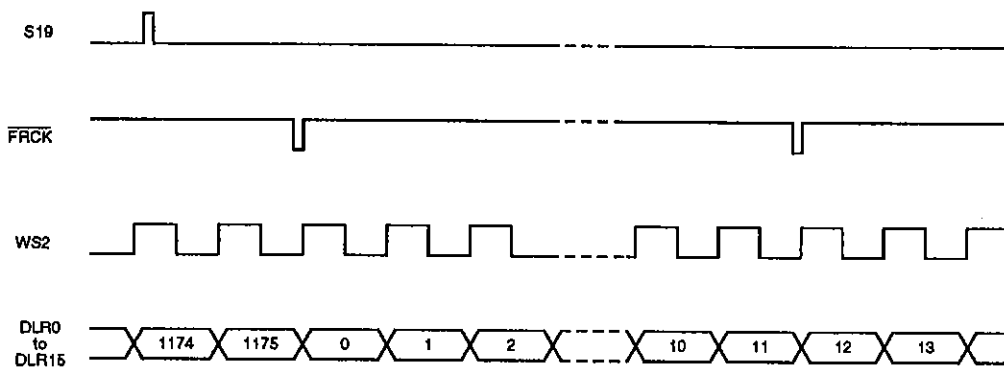
In CD-ROM or CD-I format data processing modes, bit scrambling is OFF when \overline{BSBOFF} is LOW, and ON when \overline{BSBOFF} is HIGH.

When \overline{MASTER} is LOW, master operation mode is selected and $\overline{WS2}$, \overline{FRCK} and $S0$ are outputs. When \overline{MASTER} is HIGH, slave operation mode is selected and $\overline{WS2}$, \overline{FRCK} and $S0$ are inputs.

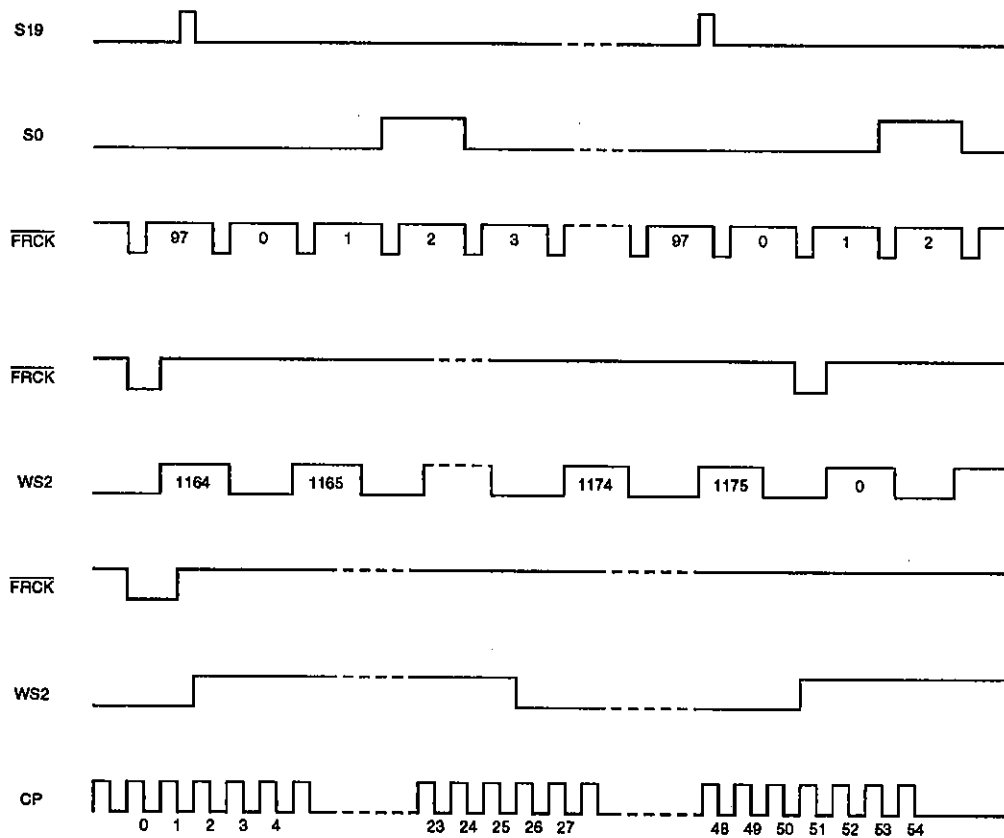
The data input sequence is shown in the following figure. After $S19$ goes LOW, data is read from $DIN0$ goes $DIN15$ when DIN goes HIGH.



The data output sequence is shown in the following figure. Note that encoded data output lags 2 sectors behind the input.



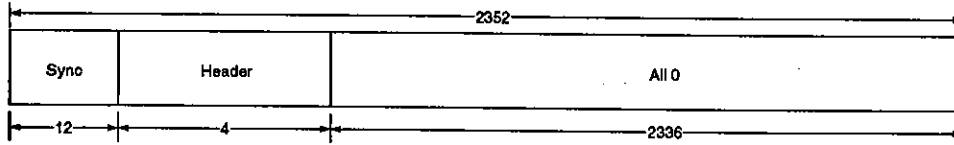
The timing of S0, $\overline{\text{FRCK}}$, WS2 and CP is shown in the following figure



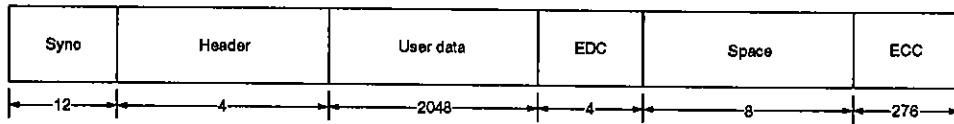
Data Formats

CD-ROM

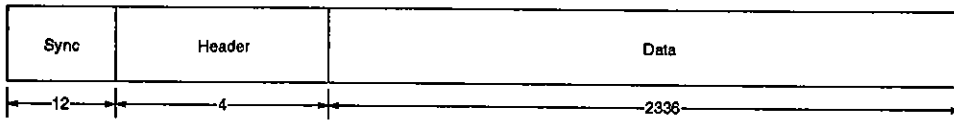
Mode 0



Mode 1

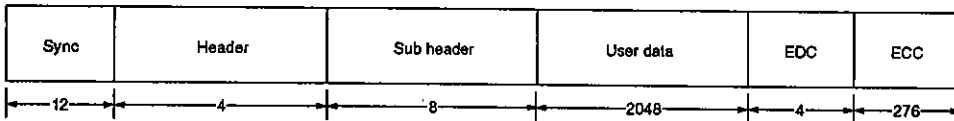


Mode 2

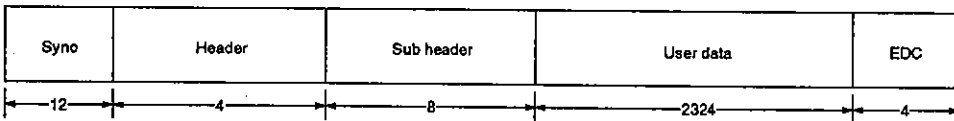


CD-I

Mode 2, form 1



Mode 2, form 2



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